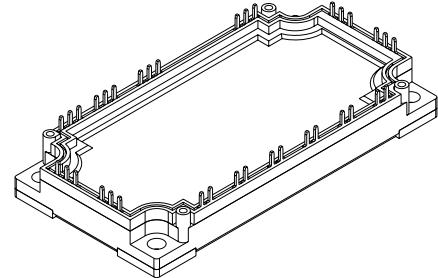
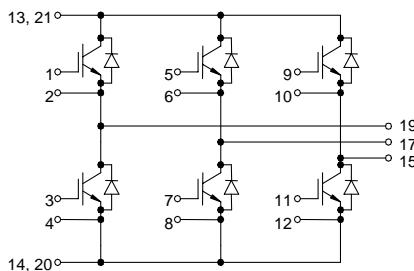


IGBT Modules

Sixpack

Short Circuit SOA Capability
Square RBSOA

I_{C25} = 130 A
 V_{CES} = 600 V
 $V_{CE(sat)\text{ typ.}}$ = 2.0 V



IGBTs

Symbol	Conditions	Maximum Ratings		
V_{CES}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	600		V
V_{GES}		± 20		V
I_{C25}	$T_C = 25^\circ\text{C}$	130		A
I_{C80}	$T_C = 80^\circ\text{C}$	88		A
RBSOA	$V_{GE} = \pm 15 \text{ V}$; $R_G = 2.2 \Omega$; $T_{VJ} = 125^\circ\text{C}$ Clamped inductive load; $L = 100 \mu\text{H}$	$I_{CM} = 200$		A
		$V_{CEK} \leq V_{CES}$		
t_{sc} (SCSOA)	$V_{CE} = V_{CES}$; $V_{GE} = \pm 15 \text{ V}$; $R_G = 2.2 \Omega$; $T_{VJ} = 125^\circ\text{C}$ non-repetitive	10		μs
P_{tot}	$T_C = 25^\circ\text{C}$	410		W

Symbol	Conditions	Characteristic Values		
		$(T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{CE(sat)}$	$I_C = 100 \text{ A}$; $V_{GE} = 15 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.0	2.5	V
		2.3		V
$V_{GE(th)}$	$I_C = 1.5 \text{ mA}$; $V_{GE} = V_{CE}$	4.5		V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		1.2 mA	mA
		0.9		mA
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$		400 nA	
$t_{d(on)}$ t_i $t_{d(off)}$ t_f E_{on} E_{off}	Inductive load, $T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 300 \text{ V}$; $I_C = 100 \text{ A}$ $V_{GE} = \pm 15 \text{ V}$; $R_G = 2.2 \Omega$	25		ns
		11		ns
		150		ns
		30		ns
		1.0		mJ
		2.9		mJ
C_{ies} Q_{Gon}	$V_{CE} = 25 \text{ V}$; $V_{GE} = 0 \text{ V}$; $f = 1 \text{ MHz}$ $V_{CE} = 300 \text{ V}$; $V_{GE} = 15 \text{ V}$; $I_C = 100 \text{ A}$	4.3		nF
		tbd		nC
R_{thJC}	(per IGBT)		0.3	K/W

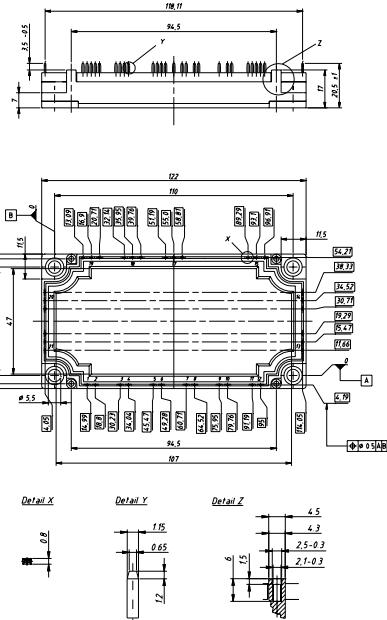
IXYS reserves the right to change limits, test conditions and dimensions.

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Diodes

Symbol	Conditions	Maximum Ratings		
I_{F25}	$T_C = 25^\circ\text{C}$	140	A	
I_{F80}	$T_C = 80^\circ\text{C}$	88	A	

Dimensions in mm (1 mm = 0.0394")



Symbol Conditions

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 100 \text{ A}; V_{GE} = 0 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.9 1.4	2.1 V	V
t_{rr}	$\left. \begin{array}{l} I_F = 60 \text{ A}; dI_F/dt = -500 \text{ A}/\mu\text{s}; T_{VJ} = 125^\circ\text{C} \\ V_R = 300 \text{ V}; V_{GE} = 0 \text{ V} \end{array} \right\}$	28 100	A ns	
R_{thJC}	(per diode)		0.61	K/W

Module

Symbol	Conditions	Maximum Ratings		
T_{VJ}		-40...+150		$^\circ\text{C}$
T_{stg}		-40...+125		$^\circ\text{C}$
V_{ISOL}	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$	2500		V~
M_d	Mounting torque (M5)	3 - 6		Nm

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
$R_{pin-chip}$		1.8		m Ω
d_s	Creepage distance on surface	10		mm
d_A	Strike distance in air	10		mm
R_{thCH}	with heatsink compound	0.01		K/W
Weight		300		g

Higher magnification see outlines.pdf